

Features

- Forward Continuous Current:I_F=150mA
- Power Dissipation of 500mw

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BAT46W-7-F	SOD-123	S 9	3000



SOD-123



Maximum Ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Peak repetitive peak reverse voltage	V_{RRM}	100	
Working peak reverse voltage	V _{RWM}		V
Forward continuous current	I _F	150	mA
Repetitive peak forward current (Note 1) @ tp < 1.0s, Duty Cycle < 50%	I _{FRM}	350	mA
Non-repetitive Peak Forward surge current @ t = 8.3ms	I _{FSM}	750	mA
Power dissipation	P _D	500	mW
Thermal resistance junction to ambient air	$R_{\theta JA}$	200	°C/W
Junction temperature	Tj	125	°C
Storage temperature	T _{STG}	-55~+150	$^{\circ}$

Electrical Characteristics(Ta=25°C unless otherwise specified)

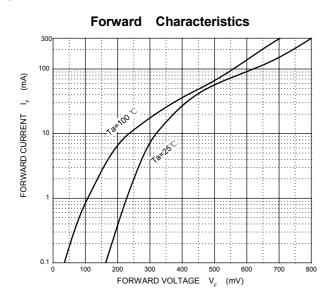
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Reverse breakdown voltage(Note 2)	V _R	I _R = 100μA	100			V
	I _R	V _{R1} =1.5V			0.3	μΑ
		V _{R2} =10V			0.5	
Reverse voltage leakage current		V _{R3} =50V			1	
		V _{R4} =75V			2	
		I _{F1} =0.1mA			0.25	V
Forward voltage(Note 2)	V _F	I _{F2} =10mA			0.45	
		I _{F3} =250mA			1	
	Ст	V _R =0, f=1MHz		20		_
Diode capacitance		V _R =1V, f=1MHz		12		pF

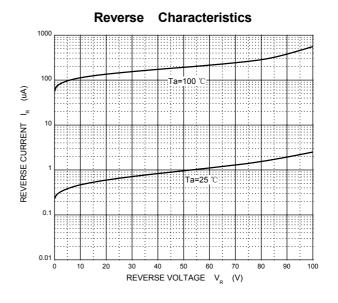
Notes: 1. Part mounted on FR-4 board with recommended pad layout.

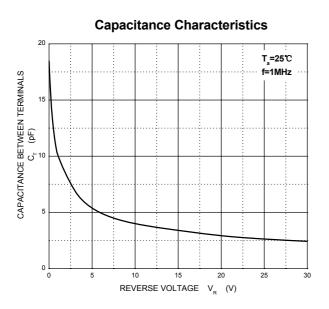
2. Short duration pulse test used to minimize self-heating effect.

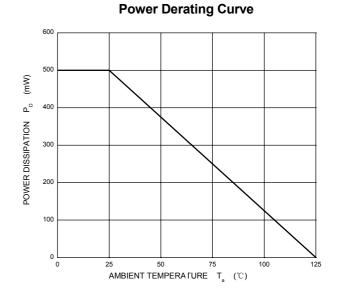


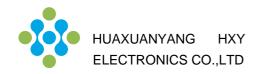
Typical Characteristics

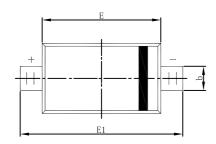


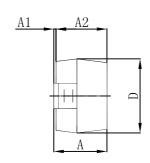


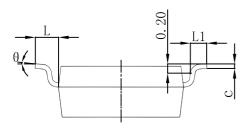




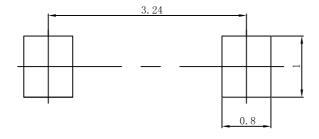








Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.450	0.650	0.018	0.026	
С	0.080	0.150	0.003	0.006	
D	1.500	1.700	0.059	0.067	
E	2.600	2.800	0.102	0.110	
E1	3.550	3.850	0.140	0.152	
L	0.500 REF		0.020 REF		
L1	0.250	0.450	0.010	0.018	
θ	0°	8°	0°	8°	



Note:

- 1. Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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